## Tactile Switches



P.C.B. LAYOUT

CIRCUIT DIAGRAM



NOTE:
1.ALL DIMENSIONS ARE IN MILLIMETER,BRACKETED DIMENSIONS ARE IN INCHES. 2.GENANAL TOLERANCES $\pm 0.20 \mathrm{~mm}$.


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1 TERMINAL TYPE:
B SMT Bending Terminals
2 TRAVEL:
13 1.3 mm
3 OPERATING FORCE:
C 200 gf
S 350 gf
4 \text { PACKAGING:}
TR Tape and Reel
```

| ITEM | DESC | Q'TY | MATERIALS | TREATMENT | REMARK |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | Stem | 1 | HIGH-TEMP <br> THERMOPLASTIC <br> NYLON UL 94V-0 | Color : Red | - |
| 2 | Silicone Dome | 1 | Silicone rubber with <br> metal contact | With Gold Plating | - |
| 3 | Base | 1 | HIGH-TEMP <br> THERMOPLASTIC <br> NYLON UL 94V-0 | Color : Black | - |
| 4 | Cover | 1 | HIGH-TEMP <br> THERMOPLASTIC <br> NYLON UL 94V-0 | Color : Black | - |
| 5 | Terminal | 1 | BRASS | With Silver Plating | - |

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## SPECIFICATIONS

## 1. Style

This specification describes "TACTILE SWITCH", mainly used as signal switch of electric devices, with the general requirements of mechanical and electrical characteristic.
1.1 Operating Temperature Range: $-40^{\circ} \mathrm{C}+85^{\circ} \mathrm{C}$
1.2 Storage Temperature Range : $-40^{\circ} \mathrm{C}+85^{\circ} \mathrm{C}$
2. Current Range: 50mA, 12 VDC
3. Type of Actuation: Tactile feedback
4. Test Sequence:

| - | ITEM | DESCRIPTION | TEST CONDITIONS | REQUIREMENTS |
| :---: | :---: | :---: | :---: | :---: |
|  | 1 | Visual Examination | By visual examination check without any out pressure \& testing. | There shall be no defects that affect the serviceability of the product. |
|  | 2 | Contact Resistance | Applying a static load 1.5~2 times the operating force to the center made with a 1 kHz small current contact resistance meter. | 100m $\Omega$ Max. |
|  | 3 | Insulation Resistance | Measurements shall be made following application of 500 V DC potential across terminals and cover for 1 minute $\pm 5$ seconds. | 100M $\Omega$ Min. |
|  | 4 | Dielectric Withstanding Voltage | $300 \mathrm{~V} \mathrm{AC}(50 \mathrm{~Hz}$ or 60 Hz$)$ shall be applied across terminals and cover for 1 minute | There shall be no breakdown or flashover. |
|  | 5 | Capacitance | $1 \mathrm{MHz} \pm 10 \mathrm{kHz}$ | 5 pF max. |
|  | 6. | Bounce | 3 to 4 operations at a rate of 1 cycles per second | 10 m seconds Max. |

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|  | 7. | Operating Force | Applied in the direction of operation. |  | C | S |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | OF |  | $\begin{gathered} 350 \mathrm{~g} \pm 100 \mathrm{~g} \\ (3.43 \mathrm{~N} \pm .98 \mathrm{~N}) \end{gathered}$ |
|  | 8. | Stroke | Placing the switch such that the direction of switch operation is vertical and then gradually increasing the load applied to the stem, the stroke distance for the stem to come to a stop shall be measured. | $1.30+0.1 /-0.3 \mathrm{~mm}$ |  |  |
|  | 9. | Stop Strength | Placing the switch such that the direction of switch operation is vertical, a static load of $5 \mathrm{kgf}(50 \mathrm{~N})$ shall be applied in the direction of stem operation for a period of 15 seconds | 1)As shown in item 4~6 <br> 2)Contact Resistance: 200m $\Omega$ Max <br> 3)Insulation Resistance: 10M $\Omega$ Min |  |  |
|  | 10. | Solder Heat Resistance | (PCB is 1.2 mm in thickness) SMT Type | 1)Shall be free from pronounced backlash and falling-off or breakage terminals <br> 2)As shown in item 4~7 <br> 3)Contact Resistance: $200 \mathrm{~m} \Omega$ Max <br> 4)Insulation Resistance: 10M $\Omega$ Min |  |  |
|  | 11. | Vibration | Shall be vibrated in accordance with Method 201A of MIL-STD-202F <br> (1) Frequency: $10-55-10 \mathrm{~Hz}$ in 1-min/cycle. <br> (2Direction: 3 vertical directions including the directions of operation <br> (3) Test time: 2 hours each direction. <br> (4) Swing distance $=1.5 \mathrm{~mm}$ | 1)As shown in item 4~7 <br> 2)Contact Resistance: $10 \Omega$ Max <br> 3)Insulation Resistance: 10M $\Omega$ Min |  |  |
|  |  |  |  |  |  |  |

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|  | 12 | Shock | Shall be shocked in accordance with Method 213B condition A of <br> MIL-STD-202F <br> 1)Acceleration; 50G <br> 2)Action time: $11 \pm 1 \mathrm{~m}$ seconds <br> 3)Testing Direction: 6 sides <br> 4)Test Cycle: 3 times in each direction | Ditto |
| :---: | :---: | :---: | :---: | :---: |
|  | 13 | $\begin{aligned} & \text { Operating } \\ & \text { Life } \end{aligned}$ | Measurements shall be made following the test forth below: <br> 1) $5 \mathrm{~mA}, 5 \mathrm{VDC}$ resistive load <br> 2)Applying a static load the operating force to the center of the stem in the direction of operation <br> 3)Cycle of Operation: 100, 000 cycles Min. For 200g 30,000 cycles Min For 350 g | 1)As shown in item 4~6 <br> 2)Operating force: $\pm 50 \%$ of initial force. <br> 3)Contact Resistance: $10 \Omega$ Max <br> 4)Insulation Resistance: 10M $\Omega$ Min <br> 5)Bounce: <br> 20 m seconds Max |
|  | 14 | Resistance Low Temperature | Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before the measurements are made: <br> 1) Temperature:- $40 \pm 2^{\circ} \mathrm{C}$ <br> 2)Time:500 hours | 1)As shown in item 4~7 <br> 2)Contact Resistance: 10ת Max <br> 3)Insulation Resistance: 10M $\Omega$ Min |
|  | 15 | $\begin{array}{\|c\|} \hline \text { Resistance } \\ \text { High } \\ \text { Temperature } \end{array}$ | Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before the measurements are made: <br> 1) Temperature: $85 \pm 2^{\circ} \mathrm{C}$ <br> 2)Time:500 hours | Ditto |
|  | 16 | Resistance Humidity | Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before the measurements are made: <br> 1) Temperature: $60 \pm 2^{\circ} \mathrm{C}$ <br> 2)Relative Humidity:90~95\% <br> 3)Time:500 hours | Ditto |

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## 5. SOLDERING CONDITIONS:

■ Condition for Reflow Soldering - S.M.T Series


TIME(sec)

- The condition mentioned above is the temperature on the Cu foil of the PCB surface. There are cases where board's temperature greatly differs from switch's surface be used not to allow switch's surface temperature to exceed $260^{\circ} \mathrm{C}$.
■ Manual Soldering

| Soldering Temperature | Max. $350^{\circ} \mathrm{C}$ |
| :--- | :---: |
| Continuous Soldering Time | Max. 5 seconds |

- Precautions in Handling

1. Care should be exercised so that flux from the upper part of the printed circuit board does not adhere to the switch.
2. Except for washable type do not wash the switch body.
